



PATENT
29926/39470

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Application of: Sang-Tae Choi and
Seung-Weon Paek

Serial No.: 10/623,419

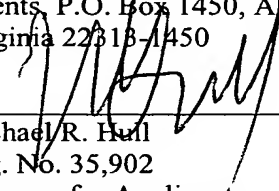
Filed: July 18, 2003

For: Method for Forming Ultra Fine
Contact Holes in Semiconductor
Devices

Group Art Unit: 1756

Examiner: To be assigned

) I hereby certify that this paper and the
) documents referred to as enclosed
) therewith are being deposited with the
) United States Postal Service as first
) class mail, postage prepaid, on
) **November 24, 2003**, in an envelope
) addressed to Commissioner for
) Patents, P.O. Box 1450, Alexandria,
) Virginia 22313-1450

) 
) Michael R. Hull
) Reg. No. 35,902
) Attorney for Applicants
)
)
)
)

TRANSMITTAL OF EXECUTED DECLARATION
AND REQUEST FOR CORRECTED FILING RECEIPT

Commissioner for Patents
P.O. Box 1450
Alexandria, Virginia 22313-1450

Sir:

Submitted herewith is an executed Declaration in response to the Notice to File Missing Parts of Nonprovisional Application issued by the U.S. Patent and Trademark Office on October 22, 2003.

A copy of the Notice together with our check in the amount of \$130.00 in payment of the requisite surcharge fee is enclosed.

Applicants request the issuance of a corrected filing receipt. A copy of the official filing receipt issued by the U.S. Patent and Trademark Office is enclosed with the following corrections noted in red: each inventor's city of residence should read **Kyungki-do** not "Ichon-shi." Accordingly, applicants respectfully request the issuance of a corrected filing receipt in connection with this application.

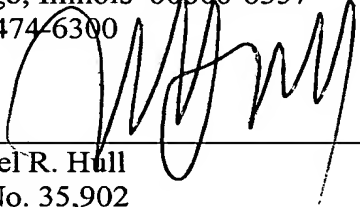
The Commissioner is hereby authorized to charge any deficiency in the amount enclosed or any additional fees which may be required under 37 C.F.R. § 1.17 to Deposit Account No. 13-2855.

Respectfully submitted,

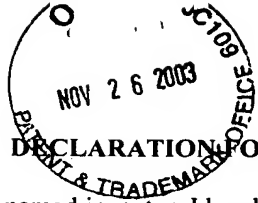
MARSHALL, GERSTEIN & BORUN LLP
6300 Sears Tower
233 South Wacker Drive
Chicago, Illinois 60606-6357
(312) 474-6300

November 24, 2003

By:



Michael R. Hull
Reg. No. 35,902

**DECLARATION FOR PATENT APPLICATION AND POWER OF ATTORNEY**

As a below named inventor, I hereby declare that my residence, post office address and citizenship are as stated below next to my name; I believe that I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled " METHOD FOR FORMING ULTRA FINE CONTACT HOLES IN SEMICONDUCTOR DEVICES

the specification of which: ☐ is attached hereto; ☒ was filed on July 18, 2003 as Application Serial No. 10/623419 and was amended on _____ (if applicable); ☐ was filed as PCT International Application No. _____ on _____ and was amended under Article 19 on _____ (if applicable). I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claims, as amended by any amendment(s) referred to above. I acknowledge the duty to disclose to the Patent and Trademark Office all information known to me to be material to patentability as defined in 37 C.F.R. §1.56.

In the event that the filing date and/or Application No. are not entered above at the time I execute this document, and if such information is deemed necessary, I hereby authorize and request my attorneys/agent(s) at Marshall, Gerstein & Borun, 6300 Sears Tower, 233 S. Wacker Drive, Chicago, IL 60606-6357, to insert above the filing date and/or Application No. of said application.

I hereby claim foreign priority benefits under 35 U.S.C. §119 of any foreign application(s) for patent or inventor's certificate or of any PCT international application(s) designating at least one country other than the United States of America listed below and have also identified below any foreign application(s) for patent or inventor's certificate or any PCT international application(s) designating at least one country other than the United States of America filed by me on the same subject matter having a filing date before that of the application(s) of which priority is claimed:

			Priority Claimed	
<u>2002-42319</u>	<u>Republic of Korea</u>	<u>19/07/2002</u>	<input checked="" type="checkbox"/>	<input type="checkbox"/>
(Application Serial Number)	(Country)	(Day/Month/Year Filed)	Yes	No
_____	_____	_____	<input type="checkbox"/>	<input type="checkbox"/>
(Application Serial Number)	(Country)	(Day/Month/Year Filed)	Yes	No

I hereby claim the benefit under 35 U.S.C. §119(e) of any United States provisional application(s) listed below:

_____	_____
(Application Serial Number)	(Day/Month/Year Filed)
_____	_____
(Application Serial Number)	(Day/Month/Year Filed)

I hereby claim the benefit under 35 U.S.C. §120 of any United States application(s) or PCT international application(s) designating the United States of America listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior application(s) in the manner provided by the first paragraph of 35 U.S.C. §112, I acknowledge the duty to disclose to the Office all information known to me to be material to patentability as defined in 37 C.F.R. §1.56 which occurred between the filing date of the prior application(s) and the national or PCT international filing date of this application:

_____	_____	_____
(Application Serial Number)	(Day/Month/Year Filed)	(Status-Patented, Pending or Abandoned)
_____	_____	_____
(Application Serial Number)	(Day/Month/Year Filed)	(Status-Patented, Pending or Abandoned)

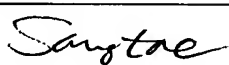
I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under 18 U.S.C. §1001 and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

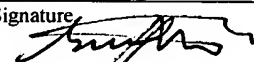
POWER OF ATTORNEY: I hereby appoint as my attorneys, with full powers of substitution and revocation, to prosecute this application and transact all business in the Patent and Trademark Office connected therewith:

John B. Lungmus	18,566	Kevin D. Hogg	31,839	Gregory C. Mayer	38,238
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Date	Signature